

# 10Gb/s XFP DWDM 100km Optical Transceiver Module DC-DX92XXx-100

#### **Features**

- Supports 9.95Gb/s to 11.3Gb/s bit rates
- DWDM EML transmitter and APD receiver
- 100 GHz ITU channel spacing with integrated wavelength locker
- Up to 100km on 9/125µm SMF
- Hot-pluggable XFP footprint
- Supports Lineside and XFI loopback
- Built-in digital diagnostic functions
- Full Duplex LC connector
- RoHS-10 compliant and lead-free
- Single +3.3V power supply
- No Reference Clock required
- Power dissipation <2.0W
- Metal enclosure, for lower EMI
- Meet ESD requirements, resist 8KV direct contact voltage
- Case operating temperature

Commercial: 0 ~ +70°C

Extended: -10 ~ +80°C

Industrial:  $-40 \sim +85^{\circ}$ C

## **Applications**

- 10GBASE-ZR/ZW & 10G Ethernet
- SONET OC-192 &SDH STM I-64.1
- 10G Fiber Channel



# **Part Number Ordering Information**

Part Number	Data Rate (Gb/s)	Wavelength (nm)	Transmission Distance(km)	Temperature (°C) (Operating Case)
DC-DX92XXC- 100	10.3125	Refer to wavelength selection	100km SMF	0~70 commercial
DC-DX92XXE- 100	10.3125	Refer to wavelength selection	100km SMF	-10~80 Extended
DC-DX92XXI-100	10.3125	Refer to wavelength selection	100km SMF	-40~85 Industrial

# Wavelength Selection: C-band λc Wavelength Guide Pin Descriptions

Channel	Wavelength (nm)	Frequency (THZ)	Channel	Wavelength (nm)	Frequency (THZ)
C17	1563.86	191.70	C39	1546.12	193.90
C18	1563.05	191.80	C40	1545.32	194.00
C19	1562.23	191.90	C41	1544.53	194.10
C20	1561.42	192.00	C42	1543.73	194.20
C21	1560.61	192.10	C43	1542.94	194.30
C22	1559.79	192.20	C44	1542.14	194.40
C23	1558.98	192.30	C45	1541.35	194.50
C24	1558.17	192.40	C46	1540.56	194.60
C25	1557.36	192.50	C47	1539.77	194.70
C26	1556.55	192.60	C48	1538.98	194.80



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C27	1555.75	192.70	C49	1538.19	194.90
C28	1554.94	192.80	C50	1537.40	195.00
C29	1554.13	192.90	C51	1536.61	195.10
C30	1553.33	193.00	C52	1535.82	195.20
C31	1552.52	193.10	C53	1535.04	195.30
C32	1551.72	193.20	C54	1534.25	195.40
C33	1550.92	193.30	C55	1533.47	195.50
C34	1550.12	193.40	C56	1532.68	195.60
C35	1549.32	193.50	C57	1531.90	195.70
C36	1548.51	193.60	C58	1531.12	195.80
C37	1547.72	193.70	C59	1530.33	195.90
C38	1546.92	193.80	C60	1529.55	196.00
Non-ITU	Peak wavelength between 1528.77nm-1563.86		C61	1528.77	196.10



## I. Absolute Maximum Ratings

It has to be noted that the operation in excess of any individual absolute maximum ratings might cause permanent damage to this module.

Parameter	Symbol	Min	Max	Unit	Unit
Storage Temperature	$T_{S}$	-40	85	°C	
Power Supply Voltage	$V_{CC}$	-0.5	3.6	V	
Relative Humidity (non-condensation)	RH	5	95	%	
Damage Threshold	$TH_d$	0		dBm	

# II. Recommended Operating Conditions and Power Supply Requirements

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Operating Case Temperature	$T_{OP}$	See order Information			°C	
Power Supply Voltage	$V_{CC}$	3.135	3.3	3.465	V	
Data Rate			10.3125		Gb/s	
Control Input Voltage High		2		Vcc	V	
Control Input Voltage Low		0		0.8	V	
Link Distance (SMF)	D			100	km	9/125um

## **III. General Description**

Do-networks' DC-DX92XXx-100 XFP transceiver is designed for use in 10-Gigabit Ethernet links up to 100km over single mode fiber. The module consists of DWDM EML Laser, APD and Preamplifier in a high-integrated optical sub-assembly. Digital diagnostics functions are available via a 2-wire serial interface, as specified in XFP MSA. This module is designed for single mode fiber and operates at a nominal wavelength of 100GHz ITU Grid, C Band DWDM wavelength.





DC-DX92XXx-100 transceivers provide a unique enhanced digital diagnostic monitoring interface, which allows real-time access to device operating parameters such as transceiver temperature, laser bias current, transmitted optical power, and received optical power and transceiver supply voltage. It also defines a sophisticated system of alarm and warning flags, which alerts end-users when particular operating parameters are outside of a factory set normal range.

The XFP MSA defines a 256-byte memory map in EEPROM that is accessible over a 2-wire serial interface at the 8 bit address 1010000X (A0h). The digital diagnostic monitoring interface makes use of the 8 bit address 1010001X (A2h), so the originally defined serial ID memory map remains unchanged.

## **IV. Pin Assignment and Pin Description**

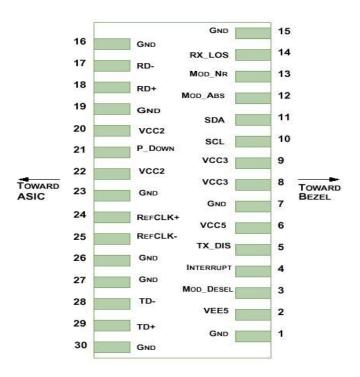


Figure 1. Diagram of host board connector block pin numbers and names

Pin	Symbol	Name/Description	Notes
1	GND	Module Ground	1



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2	VEE5	Ontional 5.2 Dayyar Supply Not required	
2	VEE5	Optional –5.2 Power Supply – Not required  Module De-select; When held low allows the module to	
3	Mod-Desel	respond to 2-wire serial interface commands	
4	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface	2
5	TX_DIS	Transmitter Disable; Transmitter laser source turned off	
6	VCC5	+5 Power Supply – Not required	
7	GND	Module Ground	1
8	VCC3	+3.3V Power Supply	
9	VCC3	+3.3V Power Supply	
10	SCL	Serial 2-wire interface clock	
11	SDA	Serial 2-wire interface data line	2
12	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	2
13	Mod_NR	Module Not Ready; Do-networks's defines it as a logical OR between RX_LOS and Loss of Lock in TX/RX.	2
14	RX_LOS	Receiver Loss of Signal indicator	2
15	GND	Module Ground	1
16	GND	Module Ground	1
17	RD-	Receiver inverted data output	
18	RD+	Receiver non-inverted data output	
19	GND	Module Ground	1
20	VCC2	+1.8V Power Supply – Not required	
21	P_Down/RST	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset	
21	T_DOWN/KST	Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22	VCC2	+1.8V Power Supply – Not required	
23	GND	Module Ground	1
24	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board – Not required	3
25	RefCLK-	Reference Clock inverted input, AC coupled on the host board — Not required	3
26	GND	Module Ground	1



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27	GND	Module Ground	1
28	TD-	Transmitter inverted data input	
29	TD+	Transmitter non-inverted data input	
30	GND	Module Ground	1

#### Notes:

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector; should be pulled up with  $4.7k\Omega$ - $10k\Omega$  on host board to a voltage between 3.15V and 3.6V.
- 3. A Reference Clock input is not required by the DC-DX92XXx-100. If present, it will be ignored.

### V. Electrical Characteristics

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min.	Тур.	Max	Unit	Notes
Power Consumption	P			2.0	W	1
Supply Current	Icc			580	mA	
	Trans	mitter				
Single-ended Input Voltage Tolerance	Vcc	-0.3		4.0	V	
Differential Input Voltage Swing	Vin,pp	120		820	mVpp	
Differential Input Impedance	Zin	90	100	110	Ohm	2
Transmit Disable Assert Time				10	us	
Transmit Disable Voltage	Vdis	Vcc-1.3		Vcc	V	3
Transmit Enable Voltage	Ven	Vee		Vee +0.8	V	
	Rece	eiver				
Differential Output Voltage Swing	Vout,pp	650		850	mVpp	
Differential Output Impedance	Zout	90	100	110	Ohm	4
Data output rise/fall time	Tr/Tf			38	ps	5
LOS Assert Voltage	VlosH	Vcc-1.3		Vcc	V	6



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LOS De-assert Voltage	VlosL	Vee	Vee +0.8	V	6
Power Supply Rejection	PSR				7

#### Notes:

- 1. Maximum total power value is specified across the full temperature and voltage range.
- 2. After internal AC coupling.
- 3. Or open circuit.
- 4. In to 100 ohms differential termination.
- 5. These are unfiltered 20-80% values
- 6. Loss of Signal is open collector to be pulled up with a  $4.7k\Omega$ - $10k\Omega$  resistor to 3.15-3.6V. Logic 0 indicates normal operation; logic 1 indicates no signal detected.
- 7. Per Section 2.7.1. in the XFP MSA Specification1.

## **VI. Optical Characteristics**

Parameter	Symbol	Min.	Typical	Max	Unit	Notes			
Transmitter									
Optical Wavelength	λο	λc -0.1		λc +0.1	nm	1			
Center Wavelength Spacing			100		GHz				
Optical Spectral Width	Δλ			1	nm				
Side Mode Suppression Ratio	SMSR	30			dB				
Average Optical Power	$P_{AVG}$	1		5	dBm	2			
Optical Extinction Ratio	ER	8.2			dB				
Transmitter and Dispersion Penalty	TDP			2	dB				
Transmitter OFF Output Power	POff			-30	dBm				
Transmitter Eye Mask	Compliant with IEEE802.3ae								
		Receiver							
Center Wavelength	$\lambda_{\mathrm{C}}$	1270		1610	nm				



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Receiver Sensitivity (Average Power)	Sen.		-25	dBm	3
Input Saturation Power (overload)	Psat	-8		dBm	
LOS Assert	LOSA	-37		dB	
LOS De-assert	LOSD		-27	dBm	
Receiver Reflectance	Rrx		-27	dB	
LOS Hysteresis	LOSH	0.5		dBm	

The following optical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

#### Notes:

- 1.  $\lambda c$  refer to wavelength selection, and corresponds to approximately 0.8 nm
- 2. Class 1 Laser Safety per FDA/CDRH and IEC-825-1 regulations.
- 3. Measured with Light source 1528.77~1563.86nm, ER=8.2dB; BER =<10^-12 @10.3125Gbps, PRBS=2^31-1 NRZ.

## **VII. Digital Diagnostic Functions**

The following digital diagnostic characteristics are defined over the normal operating conditions unless otherwise specified.

Parameter	Symbol	Min.	Max	Unit	Notes
Temperature monitor absolute error	DMI_ Temp	-3	3	degC	Over operating temp
Supply voltage monitor absolute error	DMI_VCC	-0.15	0.15	V	Full operating range
RX power monitor absolute error	DMI_RX	-3	3	dB	
Bias current monitor	DMI_ bias	-10%	10%	mA	
TX power monitor absolute error	DMI_TX	-3	3	dB	

### **VIII. Mechanical Dimensions**





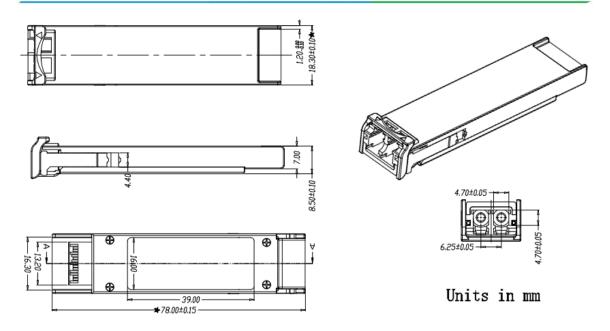


Figure 2. Mechanical Outline

# **IX. Revision History**

Version No.	Initiated	Revised contents	Release Date
1.0	Andy Zhang	Preliminary datasheet	2014-06-11
1.1	Andy Zhang	Mechanical Change	2016-04-08

### X. Precautions

- a. This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.
- b. Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.